

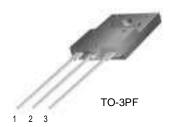
FFAF10U40DN

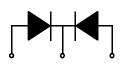
Features

- · Ultrafast with soft recovery
- · Low forward voltage

Applications

- Power switching circuits
- Output rectifiers
- Freewheeling diodes
- Switching mode power supply





1. Anode 2. Cathode 3. Anode

ULTRA FAST RECOVERY POWER RECTIFIER

Absolute Maximum Ratings (per diode) T_C=25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------------------------|--|--------------|-------|
| V _{RRM} | Peak Repetitive Reverse Voltage | 400 | V |
| I _{F(AV)} | Average Rectified Forward Current @ T _C = 100°C | 10 | А |
| I _{FSM} | Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave | 100 | А |
| T _{J,} T _{STG} | Operating Junction and StorageTemperature | - 65 to +150 | °C |

Thermal Characteristics

| Symbol | Parameter | Value | Units |
|--------|--|-------|-------|
| Reic | Maximum Thermal Resistance, Junction to Case | 4.0 | °C/W |

Electrical Characteristics (per diode) T_C=25 °C unless otherwise noted

| Symbol | Parameter | | Min. | Тур. | Max. | Units |
|-------------------|---------------------------------------|---|------|------|------|-------|
| V _{FM} * | Maximum Instantaneous Forward Voltage | | | | | V |
| | I _F = 10A | T _C = 25 °C T _C = 100 °C | - | - | 1.4 | |
| | I _F = 10A | T _C = 100 °C | - | - | 1.3 | |
| I _{RM} * | Maximum Instantaneous Reverse Current | | | | | μΑ |
| | @ rated V _R | $T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$ | - | - | 30 | |
| | | T _C = 100 °C | - | - | 300 | |
| t _{rr} | Maximum Reverse Recovery Time | | - | - | 50 | ns |
| I _{rr} | Maximum Reverse Recovery Current | | - | - | 4.5 | Α |
| Q_{rr} | Maximum Reverse Recovery Charge | | - | - | 113 | nC |
| | $(I_F = 10A, di/dt = 200A/\mu s)$ | | | | | |
| W _{AVL} | Avalanche Energy | | 1.0 | - | - | mJ |

^{*} Pulse Test: Pulse Width=300µs, Duty Cycle=2%

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Typical Characteristics

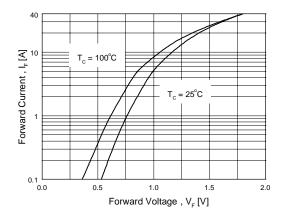


Figure 1. Typical Forward Voltage Drop vs. Forward Current

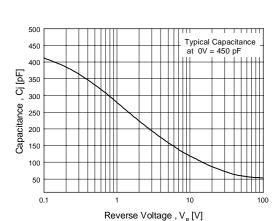


Figure 3. Typical Junction Capacitance

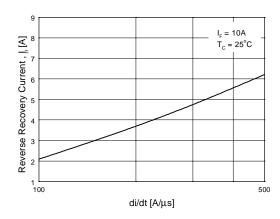


Figure 5. Typical Reverse Recovery Current vs. di/dt

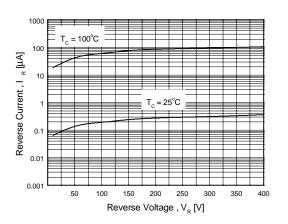


Figure 2. Typical Reverse Current vs. Reverse Voltage

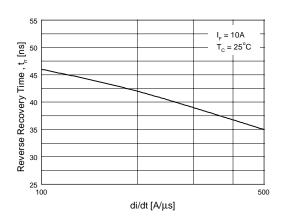


Figure 4. Typical Reverse Recovery Time vs. di/dt

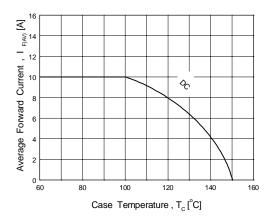
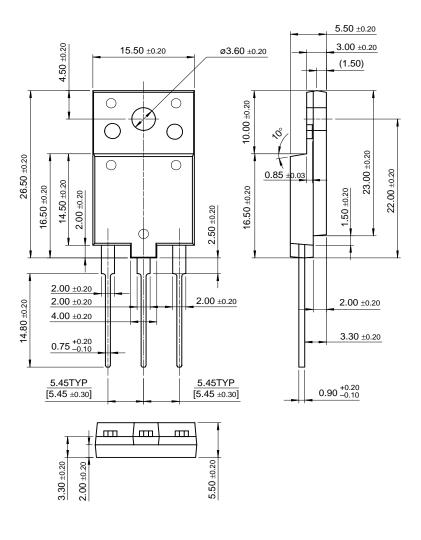


Figure 6. Forward Current Derating Curve

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Package Dimensions

TO-3PF



Dimensions in Millimeters

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|--------------------------|---------------------------|---|
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